







Ultra-Low-THD Dual-SPDT (0.35Ω) Analog Switch with Negative Signal Handling Capability

Features

- → CMOS Technology for Bus and Analog Applications
- → Negative Signal Handling Capability at all Ports
- \rightarrow Low On-Resistance: 0.35 Ω at 1.8V Supply
- \rightarrow On-Resistance Flatness 0.001Ω
- → Wide VDD Range: 1.65V to 4.3V
- → 2.0Vrms analog signal range
- → Programmable soft-start and soft-stop time
- → -3dB Bandwidth: 255MHz
- → High Off Isolation: -85dB @ 30kHz
- → Low THD: 0.0003% from 20Hz to 20kHz, 0.5VRMS
- → Crosstalk Rejection Reduces Signal Distortion: -85dB @ 30kHz
- → High-impedance mode when VDD not applied
- → ESD: 4kV for HBM mode, 1kV for CDM mode
- → Extended Industrial Temperature Range: -40°C to 85°C
- → Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- → Halogen and Antimony Free. "Green" Device (Note 3)
- → Packaging (Pb-free & Green): -10-contact UQFN (ZM10)

Applications

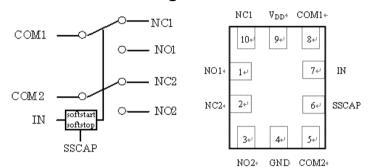
- → Cell Phones, PDAs, MP3 Players
- → Portable Instrumentation
- → Computer Peripherals
- → Speaker Headset Switching
- → Power Routing
- → Relay Replacement
- → Audio and Video Signal Routing
- → PCMCIA Cards
- → Modems

Description

PI3A288 is a dual, single-pole double throw (SPDT) CMOS switch with negative signal handling capability at all ports. It can be used as an analog switch or as a low-delay bus switch. Operating over a wide power supply voltage ranges from 1.65V to 4.3V, PI3A288 processes a low on-resistance and distortion. The ultra-low THD performance enables PI3A288 to apply in high-quality audio applications.

PI3A288 has also a soft-start and soft-stop feature so as to minimize signal disruption during channel switching.

Functional Block Diagram



Pin Description

Pin	Name	Description			
1, 3	NO _X	Data Ports (Normally open)			
4	GND	Ground			
2, 10	NC _X	Data Ports (Normally closed)			
5, 8	COM_X	Common Output / Data Ports			
9	V_{DD}	Positive Power Supply			
7	IN	Logic Control Pins			
6	SSCAP	Slew Rate Control Pin			

Logic Function Table

Logic Input (IN)	Function
0	NC1 Connected to COM1
	NC2 Connected to COM2
1	NO1 Connected to COM1
	NO2 Connected to COM2

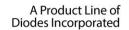
Notes

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.







Maximum Ratings

Storage Temperature65°C to +150°C
Ambient Temperature with Power Applied40°C to +85°C
Supply Voltage V _{DD} 0.5Vto +4.6V
Control Input Voltage V _{INx} 0.5Vto +4.6V
DC Input Voltage V_{INPUT} $V_{DD} - 6.0V$ and -3.1V to +3.1V
Continuous Current NO_NC_COM±350mA
Peak Current NO_NC_COM_
(pulsed at 1ms 50% duty cycle)±400mA
Peak Current NO_NC_COM_
(pulsed at 1ms 10% duty cycle)±500mA
ESD HBM mode
CDM mode

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Control input must be held HIGH or LOW; it must not float.

Recommended Operating Conditions

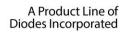
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
V_{DD}	Operating Voltage	-	1.65	-	4.3	V	
V _{IN}	Control Input Voltage	-	0	-	4.3	V	
V _{INPUT}	Switch Input Voltage	$V_{DD} = < 2.3V$		2.0		V	
		$V_{DD} > 2.3V$		1.8		V_{RMS}	
T_A	Operating Temperature	-	-40	25	85	$^{\circ}\! \mathbb{C}$	

Electrical Characteristics

 $(T_A = -40 \,^{\circ}\text{C} \text{ to } 85 \,^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at } 1.8 \,^{\circ}\text{C}.)$

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units	
ANALOG SWITCH							
Analog Cignal Dar	V _{NO} ,	$V_{DD} = < 2.3V$		2.0		\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Analog Signal Range	V_{NC} , V_{COM}	$V_{DD} > 2.3V$		1.8		$V_{ m RMS}$	
On-Resistance	R _{ON}	$V_{DD} = 1.8V, V_{COM} = 0V$ Test Circuit Figure 1	-	0.35	-	Ω	
On-Resistance Match Between Channels	ΔR_{ON}	V _{DD} = 1.8V, V _{COM} = 0V between same NC_ and NO_ channel Test Circuit Figure 1	-	0.005	0.05	Ω	
On-Resistance Flatness	R _{ONF}	$V_{DD} = 1.8V$, $V_{COM} = -2.5V$ to $+2.5V$ Test Circuit Figure 1 (NOTE1)		0.001	0.01	Ω	
Supply Current	I_{CC}	$V_{DD} = 1.8V$	-	70	110	μΑ	
DIGITAL INPUTS	DIGITAL INPUTS						
Input Logic High	V_{IH}		1.4			V	
Input Logic Low	$V_{\rm IL}$				0.325	V	
IN Input Leakage Current	I_{IN}	$V_{DD} = 1.8V, V_{IN} = 0 \text{ or } 1.8V$	-0.5	-	0.5	μΑ	
DYNAMIC CHARACTERISTICS							
Turn-Off Time	t _{OFF}	$V_{NO_}$ or $V_{NC_} = 3V$, $R_L = 32\Omega$ SSCAP=float		65		μs	
Turn-On Time	t _{ON}	$V_{NO_}$ or $V_{NC_} = 3V$, $R_L = 32\Omega$ SSCAP=float		270		μs	
Soft-Start Time	t_{START}	SSCAP=0.01uF V _{NC} _ = 0.1V, 10% to 90%		5		ms	
Soft-Stop Time	t_{STOP}	SSCAP=0.01uF V _{NC} _ = 0.1V, 90% to 10%		5		ms	
NC-NO and COM- NC/NO Off-Isolation	O _{ISO}	V _{BIAS} =0V, V _{IN} =0dBm See Test Circuit 30kHz Figure 2 and Figure 3	-	-85	-	dB	







Channel-to-Channel Crosstalk	X _{TALKD}	V _{BIAS} =0V, V _{IN} =0dBm See Test Circuit Figure 4	30kHz	-	-85	-	dB
-3dB Bandwidth	f_{3dB}	V _{BIAS} =0V, V _{IN} =0dBm See Test Circuit Figure 5		-	255	-	MHz
Total Harmonic Distortion	THD+N	f =20Hz to 20kHz, R_L =32Ω, V_{IN} =0.5 V_{RMS} , V_{BIAS} =0 V (NOTE2)		-	-110	-	dB

Note 1 and Note 2 : These parameters are measured on TA=25 $^{\circ}$ C

Capacitance

Parameter	Symbol	Test Conditions		Тур.	Max.	Units
Control Pin Input Capacitance	C_{IN}	V _{DD} =0V, f=1MHz,	-	6	-	
NC Off Capacitance	C _{NC (OFF)}	V_{DD} =1.8V, f = 1MHz, See Test Circuit Figure 6.	-	14	-	ωV
NO Off Capacitance	C _{NO (OFF)}	V_{DD} =1.8V, f = 1MHz, See Test Circuit Figure 6.	-	14	-	pF
NC On Capacitance	C _{NC (ON)}	V_{DD} =1.8V, f = 1MHz, See Test Circuit Figure 7.	-	35	-	
NO On Capacitance	$C_{NO (ON)}$	V_{DD} =1.8V, f = 1MHz, See Test Circuit Figure 7.	-	35	-	

Test Circuits and Timing Diagrams

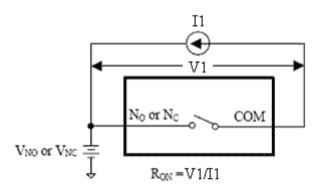


Figure 1, On Resistance

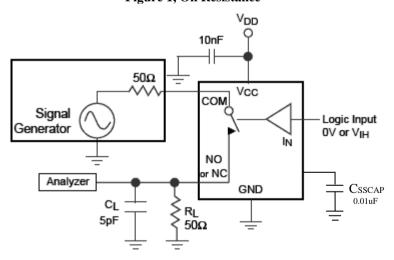


Figure 2, COM-NC/NO Isolation



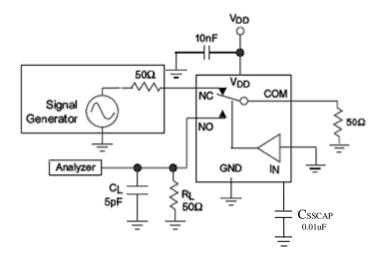
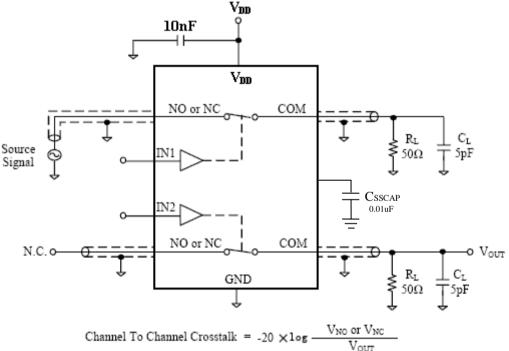


Figure 3, NC-NO Isolation



V_{OUT}

Figure 4, Channel-to-Channel Crosstalk



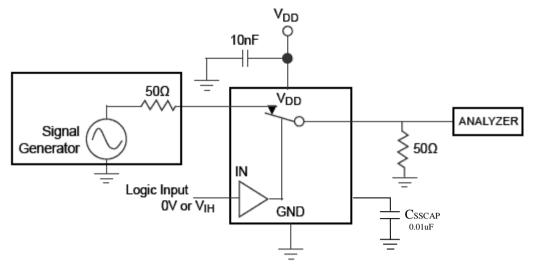


Figure 5, Bandwidth

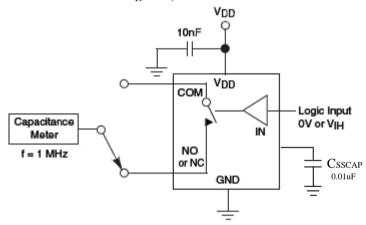


Figure 6, Channel Off Capacitance

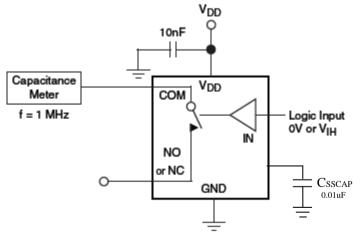
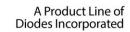


Figure 7, Channel On Capacitance







Typical Characteristics

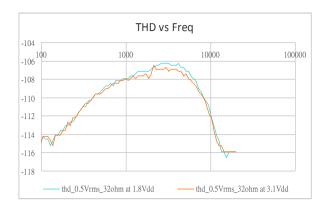


Figure 8, THD vs signal frequency

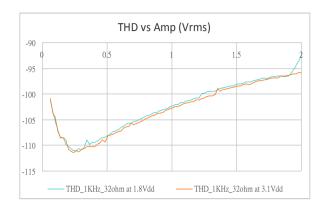


Figure 9, THD vs signal amplitude

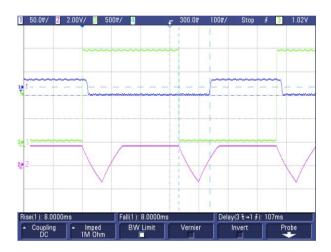


Figure 10, Soft-start with $C_{SSCAP} = 10nF$, VNC = +50mV, VNO = 0V

Channel 1 = COM

Channel 2 = SSCAP

Channel 3 = IN

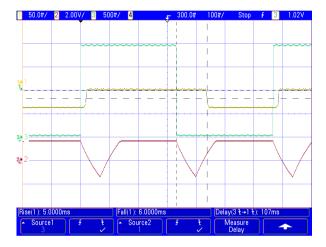


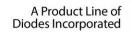
Figure 11, Soft-start with CSSCAP = 10nF, VNC = - 50mV, $\overline{\mathbf{VNO}} = \mathbf{0V}$

Channel 1 = COM

Channel 2 = SSCAP

Channel 3 = IN







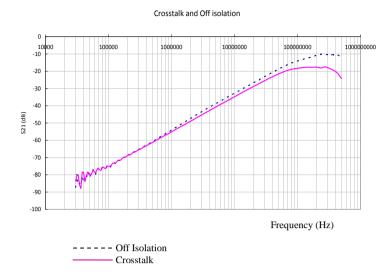


Figure 12, Crosstalk and Isolation

Typical Application Circuit

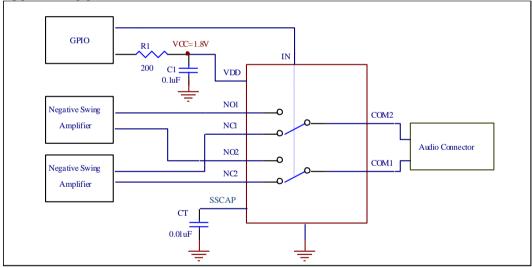


Figure 12, Crosstalk and Isolation

Function Description

The PI3A288 is an ultra-small, ultra-low THD, low on-resistance, high ESD-protected DPDT switch that operates from a +1.65V to 4.3V supply. These switches feature the low on-resistance (RON) necessary for high-performance switching applications. The Beyond-the-Rails signal capability of the PI3A288 allows signals below ground and above VCC to pass without distortion.

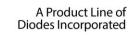
Analog Signal Levels

The topology of the switches allows the signal to drop below ground without the need of an external negative voltage supply. The devices can also withstand analog signal levels of 2Vrms. in the case of lower VDD voltage.

Digital Control Input

The PI3A288 provides a single-bit control logic input, IN. IN controls the switch position. The logic control inputs can be driven up to +4.3V regardless of the supply voltage. For example, given a +3.3V supply, the output enables or select pins may be driven to low to 0V and high to 4.3V.







Click and Pop Operation

The PI3A288 can pass ground referenced audio signals which allows it to be directly connected to audio drivers that output ground referenced audio signals, eliminating the need for a DC blocking capacitor. Audio drivers that swing around ground, however, do generate some DC offset, from a few millivolts to tens of millivolts. When switching between audio channels or muting the audio signal, these small DC offset levels of the drivers can lead to a voltage step across the speaker loads and create unwanted clicks and pops.

The PI3A288 has a special soft-start feature that slowly ramps the DC offset voltage from the audio driver to the speaker load when turning on a switch channel. The ramp rate at the load is determined by the capacitor value connected at the SSCAP pin. A soft-start capacitor value of $0.01\mu F$ provides obvious effect of eliminating pop-click noise and is recommended.

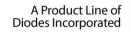
Part Marking

ZM Package



YW: Year & Workweek

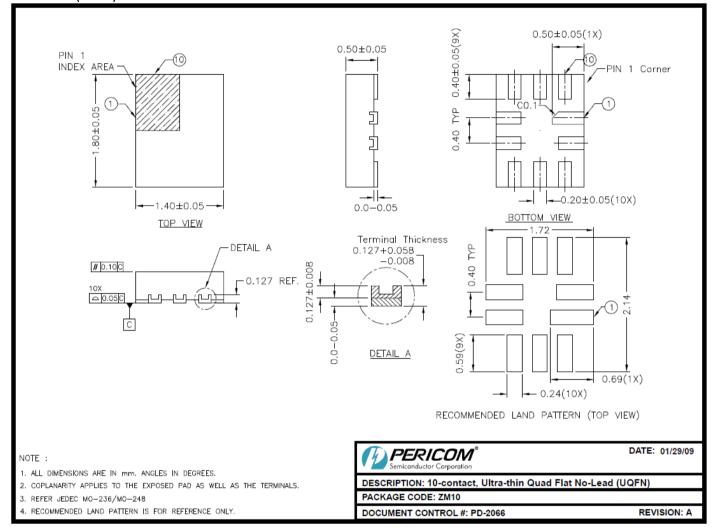






Packaging Mechanical

10- UQFN (ZM10)



For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

Ordering Information

Part Numbers	Package Code	Package
PI3A288ZMEX	ZM	10-contact, Ultra-thin Quad Flat No-Lead (UQFN)

Notes:

- ${\tt 1.} \qquad {\tt No~purposely~added~lead.~Fully~EU~Directive~2002/95/EC~(RoHS),~2011/65/EU~(RoHS~2)~\&~2015/863/EU~(RoHS~3)~compliant.}$
- See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. E = Pb-free and Green
- 5. X suffix = Tape/Reel





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